

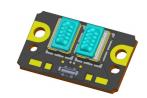
Part No. NUBB28T

■Features

- High Power Multiple Laser Diode (LD) Chip Package
- 10 Collimator Beams
- 10 series connection
- · High Heat Dissipation

Standard Operating Conditions

- Forward Current: 3.0A(CW Operation)
- T_m=70°C, ACC (Auto Current Control) Operation



■ Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Ratings	Unit
Forward Current	I_F	3.5	A
Allowable Reverse Current	I_R	85	mA
Storage Temperature	T_{stg}	-40 ~ 85	°C
Operating Temperature	T _m	0 ~ 70	°C

■Initial Electrical/Optical Characteristics

 $(T_m=25^{\circ}C)$

Item		Condition	Symbol	Min	Тур.	Max	Unit
Optical Output Power		I _F =3.0A	Po	-	(54)	-	W
Dominant Wave	length	I _F =3.0A	λ_d	449	(455)	461	nm
Threshold Curre	ent	CW	I_{th}	240	-	440	mA
Slope Efficiency	/	CW	η	-	(20.2)	-	W/A
Forward Voltage	e *1	I _F =3.0A	\mathbf{V}_{F}	-	(40)	-	V
Beam Pointing	Γilt Angle *2	I _F =3.0A	Δθ	-	-	1.2	۰
Beam Divergence *3	Parallel	I _F =3.0A	θ//	0	(0.8)	1.6	
	Perpendicular		θ_{\perp}	-1.5	(0)	1.5	

^() are reference figures.

- *1: When connected in series with the 10 LD chips.
- *2: The beam pointing tilt angle measurement is performed for the total emission area once the LD initiates laser oscillation. To calculate the beam pointing tilt angle, the following equation is used: $\Delta\theta = \sqrt{\Delta\theta_0 / ^2 + \Delta\theta_1 / ^2}$
- *3: Full angle at 1/e² from peak intensity (Total Emission Area)

All figures in this specification are measured by Nichia's method and may contain measurement deviations.

This model is Test Sample for evaluation or design purpose only. Life time is not guaranteed.

The above specifications are for reference purpose only and subjected to change without prior notice.

NICHIA CORPORATION

http://www.nichia.co.jp

♦ HEADQUARTERS

491 Oka, Kaminaka-Cho, Anan-Shi, TOKUSHIMA 774-8601, JAPAN

PHONE: +81-884-22-2311 FAX: +81-884-21-0148

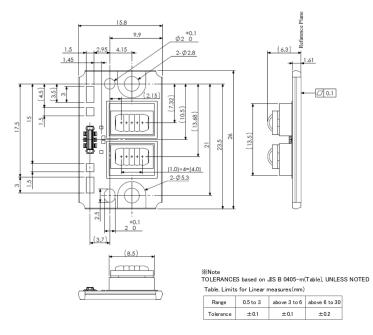
◆ CONTACT

TOKYO SALES OFFICE

13F Tamachi Center Building 34-7, Shiba 5-Chome, Minato-Ku, TOKYO 108-0014, JAPAN PHONE: +81-3-3456-3746 FAX: +81-3-5440-7516



■Outline Dimensions



Dimensions are in millimeters
() are reference figures

■LD chips Position No. & Pad Connection

